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June 2009

## NC7SBU3157, FSAU3157 Low-Voltage SPDT Analog Switch or 2:1 Multiplexer / De-multiplexer Bus Switch

#### **Features**

- Analog and digital applications
- Space-saving, SC70 6-lead, surface-mount package
- Low on resistance: <10Ω on typical at 3.3V V<sub>CC</sub>
- Broad V<sub>CC</sub> operating range: 1.65V to 5.5V
- Rail-to-rail signal handling
- Power-down, high-impedance control input
- Over-voltage tolerance of control input to 7.0V
- Break-before-make enable circuitry
- 250 MHz, 3dB bandwidth

#### **General Description**

The NC7SBU3157 / FSAU3157 is a high-performance, single-pole / double-throw (SPDT) analog switch or 2:1 multiplexer / de-multiplexer bus switch.

The device is fabricated with advanced sub-micron CMOS technology to achieve high-speed enable and disable times and low on resistance. The break-before-make select circuitry prevents disruption of signals on the B port due to both switches temporarily being enabled during select pin switching. The device is specified to operate over the 1.65 to 5.5V  $\rm V_{CC}$  operating range. The control input tolerates voltages up to 5.5V, independent of the  $\rm V_{CC}$  operating range.

Fairchild's integrated Undershoot Hardened Circuit (UHC®) senses undershoot at the I/Os, and responds by preventing voltage differentials from developing and turning the switch on.

#### **Ordering Information**

Part Number	Top Mark	Operating Temperature Range	Eco Status	Package Description	Packing Method
NC7SBU3157P6X	U7A	-40 to +85°C	RoHS	6-Lead, SC70, EIAJ SC88, 1.25mm Wide Package	3000 Units Tape and Reel
FSAU3157P6X	U7A	-40 to +85°C	RoHS	6-Lead, SC70, EIAJ SC88, 1.25mm Wide Package	3000 Units Tape and Reel



For Fairchild's definition of Eco Status, please visit: http://www.fairchildsemi.com/company/green/rohs\_green.html.

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#### **Logic Symbol**

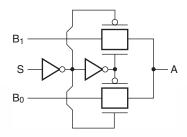


Figure 1. Logic Symbol

### **Analog Symbol**

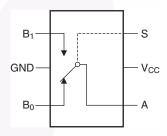
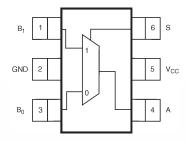


Figure 3. Analog Symbol

#### **Function Table**

Input (S)	Function
Logic Level Low	B <sub>0</sub> Connected to A
Logic Level High	B <sub>1</sub> Connected to A

#### **Connection Diagrams**



2. Pin Assignments SC70

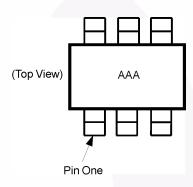


Figure 4. Pin One Orientation

#### Note:

Orientation of top mark determines pin one location. Read the top mark left to right and pin one is the lower left pin (see Figure 4).

### **Pin Descriptions**

Pin Names	Description
A, B <sub>0</sub> , B <sub>1</sub>	Data Ports
S	Control Input

#### **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only

Symbol	Parameter	Min.	Max.	Units
V <sub>CC</sub>	Supply Voltage	-0.5	+7.0	V
V <sub>S</sub>	DC Switch Voltage <sup>(1)</sup>	-0.5	V <sub>CC</sub> +0.5	V
V <sub>IN</sub>	DC Input Voltage <sup>(1)</sup>	-0.5	+7.0	V
I <sub>IK</sub>	DC Input Diode Current at V <sub>IN</sub> < 0V		-50	mA
I <sub>OUT</sub>	DC Output Current		128	mA
I <sub>CC</sub> /I <sub>GND</sub>	DC V <sub>CC</sub> or Ground Current		±100	mA
T <sub>STG</sub>	Storage Temperature Range	-65	+150	°C
T <sub>J</sub>	Junction Temperature Under Bias		+150	°C
TL	Junction Lead Temperature (Soldering, 10 seconds)		+260	°C
P <sub>D</sub>	Power Dissipation at +85°C		180	mW

#### Note

 The input and output negative voltage ratings may be exceeded if the input and output diode current ratings are observed.

#### **Recommended Operating Conditions**

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter		Min.	Max	Units
V <sub>CC</sub>	Supply Voltage Operating		1.65	5.50	V
$V_{IN}$	Control Input Voltage <sup>(2)</sup>		0	V <sub>CC</sub>	V
V <sub>IN</sub>	Switch Input Voltage <sup>(2)</sup>		0	V <sub>CC</sub>	V
V <sub>OUT</sub>	Output Voltage <sup>(2)</sup>		0	V <sub>CC</sub>	V
T <sub>A</sub>	Operating Temperature		-40	+85	°C
+ +.	Input Rise and Fall Time	Control Input V <sub>CC</sub> =2.3V-3.6V	0	10	ns/V
t <sub>r</sub> , t <sub>f</sub>	input Nise and Fair Time	Control Input V <sub>CC</sub> =4.5V-5.5V	0	5	ns/V
$\theta_{\sf JA}$	Thermal Resistance			350	°C/W

#### Note:

2. Control input must be held HIGH or LOW; it must not float.

#### **DC Electrical Characteristics**

Symbol Parameter		Conditions	V <sub>CC</sub> (V)	TA	= +25	°C	T <sub>A</sub> = -4	10°C to 5°C	Units
				Min. Typ. Max.		Min.	Max.		
V	High Level		1.65 to 1.95	0.75 V <sub>CC</sub>			0.75 V <sub>CC</sub>		.,
$V_{IH}$	Input Voltage		2.3 to 5.5	0.7 V <sub>CC</sub>			0.7 V <sub>CC</sub>		V
\/	Low Level		1.65 to 1.95			0.25 V <sub>CC</sub>		0.25 V <sub>CC</sub>	V
$V_{IL}$	Input Voltage		2.3 to 5.5			0.3 V <sub>CC</sub>		0.3 V <sub>CC</sub>	v
I <sub>IN</sub>	Input Leakage Current	$0 \le V_{IN} \le 5.5V$	0 to 5.5		±0.05	±0.1		±1	μA
I <sub>OFF</sub>	Off State Leakage Current	$0 \le A, B \le V_{CC}$	1.65 to 5.5		±0.05	±0.1		±1	μA
		V <sub>IN</sub> =0V, I <sub>O</sub> =30mA	4.5		3.0	15.0		15.0	
		V <sub>IN</sub> =2.4V, I <sub>O</sub> =-30mA			5.0	15.0		15.0	
		V <sub>IN</sub> =4.5V, I <sub>O</sub> =–30mA			7.0	15.0		15.0	
	O . Mala O .	V <sub>IN</sub> =0V, I <sub>O</sub> =24mA	3.0		4.0	20.0		20.0	
$R_{ON}$	Switch On Resistance <sup>(3)</sup>	V <sub>IN</sub> =3V, I <sub>O</sub> =-24mA			10.0	20.0		20.0	Ω
	. rooiotaires	V <sub>IN</sub> =0V, I <sub>O</sub> =8mA	2.3		5.0	30.0		30.0	
		V <sub>IN</sub> =2.3V, I <sub>O</sub> =-8mA			13.0	30.0		30.0	
	V <sub>IN</sub> =0V, I <sub>O</sub> =4mA	1.65		6.5	50.0		50.0		
		V <sub>IN</sub> =1.65V, I <sub>O</sub> =-4mA			17.0	50.0		50.0	
I <sub>CC</sub>	Quiescent Supply Current; All Channels On or Off	V <sub>IN</sub> =V <sub>CC</sub> or GND I <sub>OUT</sub> =0	5.5			1		10	μА
	Analog Signal Range		V <sub>CC</sub>	0		V <sub>CC</sub>	0	V <sub>CC</sub>	٧
		$I_A$ =-30mA, $0 \le V_{Bn} \le V_{CC}$	4.5					25.0	
D	On Resistance	$I_A$ =-24mA, $0 \le V_{Bn} \le V_{CC}$	3.0					50.0	
R <sub>RANGE</sub>	Over Signal Range	$I_A$ =-8mA, $0 \le V_{Bn} \le V_{CC}$	2.3					100	Ω
		$I_A=-4mA$ , $0 \le V_{Bn} \le V_{CC}$	1.65					300	
		I <sub>A</sub> =-30mA, V <sub>Bn</sub> =3.15	4.5		0.15				
. 5	On Resistance	I <sub>A</sub> =-24mA, V <sub>Bn</sub> 2.1	3.0		0.2				
$\Delta R_{ON}$	Match Between- Channels <sup>(3, 4, 5)</sup>	I <sub>A</sub> =-8mA, V <sub>Bn</sub> =1.6	2.3		0.5				Ω
		I <sub>A</sub> =-4mA, V <sub>Bn</sub> =1.15	1.65		0.5				1
V <sub>IKU</sub>	Voltage Under- shoot	$0.0\text{mA} \le I_{\text{IN}} \le -50, \overline{\text{OE}} 5.5\text{v}$	5.5					-2	٧
		$I_A = -30 mA, \ 0 \le V_{Bn} \le V_{CC}$	5.0		6.0				
В	On Resistance	$I_A$ =-24mA, $0 \le V_{Bn} \le V_{CC}$	3.3		12.0				
R <sub>flat</sub>	Flatness <sup>(3, 4, 6)</sup>	$I_A$ =-8mA, $0 \le V_{Bn} \le V_{CC}$	2.5		28.0				Ω
		$I_A$ =-4mA, $0 \le V_{Bn} \le V_{CC}$	1.8		125				

#### Notes

- 3. Measured by the voltage drop between A and B pins at the indicated current through the switch. On resistance is determined by the lower of the voltages on the two (A or B Ports).
- 4. Parameter is characterized, but not tested in production.
- 5.  $\Delta R_{ON} = R_{ON} \text{ max} R_{ON} \text{ minimum measured at identical } V_{CC}$ , temperature, and voltage levels.
- 6. Flatness is defined as the difference between the maximum and minimum value of on resistance over the specified range of conditions.
- 7. Guaranteed by design.

#### **AC Electrical Characteristics**

Symbol	Parameter	Conditions	V <sub>CC</sub>	T	<sub>\(\)</sub> = +25	°C	T <sub>A</sub> = -4	10°C to 5°C	Units	Figure	
			(V)	Min.	Тур.	Max.	Min.	Max.			
			1.65 to 1.95								
t <sub>PHL</sub> ,	Propagation Delay	V <sub>I</sub> = OPEN	2.3 to 2.7			1.2		1.2	ns	Figure 7	
t <sub>PLH</sub>	Bus-to-Bus <sup>(8)</sup>	VI = OPEN	3.0 to 3.6			0.8		0.8	115	Figure 8	
			4.5 to 5.5			0.3		0.3			
			1.65 to 1.95	7.0		23.0	7.0	24.0			
$t_{PZL}$ ,	Output Enable Time Turn-On Time	$V_I = 2 \times V_{CC}$ for $t_{PZL}$	2.3 to 2.7	3.5		13.0	3.5	14.0	ns	Figure 7	
$t_{PZH}$	(A to B <sub>n</sub> )	$V_I = 0V$ for $t_{PZH}$	3.0 to 3.6	2.5		6.9	2.5	7.6	1115	Figure 8	
			4.5 to 5.5	1.7		5.2	1.7	5.7	Ī		
			1.65 to 1.95	3.0		12.5	3.0	13.0			
t <sub>PLZ</sub> ,	Output Disable Time Turn-Off Time (A Port to B Port)	$V_I = 2 \times V_{CC}$ for $t_{PLZ}$	2.3 to 2.7	2.0		7.0	2.0	7.5	ns	Figure 7	
$t_{PHZ}$		$V_I = 0V$ for $t_{PHZ}$	3.0 to 3.6	1.5		5.0	1.5	5.3	115	Figure 8	
			4.5 to 5.5	0.8		3.5	0.8	3.8			
			1.65 to 1.95	0.5			0.5				
<b>4</b>	Break-Before-Make		2.3 to 2.7	0.5			0.5		ns	F: 0	
t <sub>BBM</sub>	Time <sup>(9)</sup>		3.0 to 3.6	0.5			0.5		1115	Figure 9	
			4.5 to 5.5	0.5			0.5		Ī		
Q	Charge Injection <sup>(9)</sup>	$C_L = 0.1 nF, V_{GEN} = 0 V,$	5.0		7.0				рС	Figure 10	
Q	Charge injection $R_{GEN} = 0\Omega$		3.3		3.0				рС	rigule 10	
OIRR	Off Isolation <sup>(10)</sup>	$R_L = 50\Omega$ , $f = 10MHz$	1.65 to 5.5		-57.0				dB	Figure 11	
Xtalk	Crosstalk	$R_L = 50\Omega$ , $f = 10MHz$	1.65 to 5.5		-54.0		_		dB	Figure 12	
BW	-3dB Bandwidth	$R_L = 50\Omega$	1.65 to 5.5		250				MHz	Figure 15	
THD	Total Harmonic Distortion <sup>(9)</sup>	$R_L = 600\Omega$ , 0.5 $V_{PP}$ , $f = 20Hz$ to 20KHz	5.0		.011				%		

#### Notes:

- 8. This parameter is guaranteed by design but not tested. The bus switch contributes no propagation delay other than the RC delay of the on resistance of the switch and the 50pF load capacitance, when driven by an ideal voltage source (zero output impedance).
- 9. Guaranteed by design.
- 10. Off Isolation =  $20 \log_{10} [V_A / V_{Bn}]$ .

#### Capacitance

 $T_A = +25$ °C, f = 1MHz. Capacitance is characterized, but not tested in production.

Symbol	Parameter	Conditions	Тур.	Max.	Units	Figure
C <sub>IN</sub>	Control Pin Input Capacitance	V <sub>CC</sub> = 0V	2.3		pF	
C <sub>IO-B</sub>	B Port Off Capacitance	V <sub>CC</sub> = 5.0V	6.5		pF	Figure 13
C <sub>IOA-ON</sub>	A Port Capacitance When Switch Is Enabled	V <sub>CC</sub> = 5.0V	18.5		pF	Figure 14

#### **Undershoot Characteristic**

Symbol	Parameter	Min.	Тур.	Units	Figure
V <sub>OUTU</sub>	Output Voltage During Undershoot	2.5	V <sub>OH</sub> - 0.3	V	Figure 5

#### Note:

11. This test is intended to characterize the device's protective capabilities by maintaining output signal integrity during an input transient voltage undershoot event.

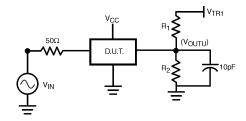


Figure 5. Output Voltage During Undershoot

#### **Device Test Conditions**

Parameter	Value	Units
V <sub>IN</sub>	see Figure 6	V
$R_1 = R_2$	100	ΚΩ
$V_{TRI}$	7.0	V
V <sub>CC</sub>	5.5	V

#### Transient Input Voltage (V<sub>IN</sub>) Waveform

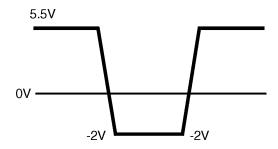
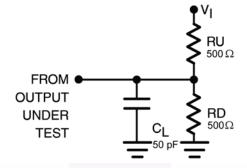


Figure 6. Transient Input Voltage Waveform

#### **AC Loading and Waveforms**



#### Notes:

Input driven by  $50\Omega$  source terminated in  $50\Omega.$   $C_L$  includes load and stray capacitance. Input PRR=1.0MHz; tw = 500ns.

Figure 7. AC Test Circuit

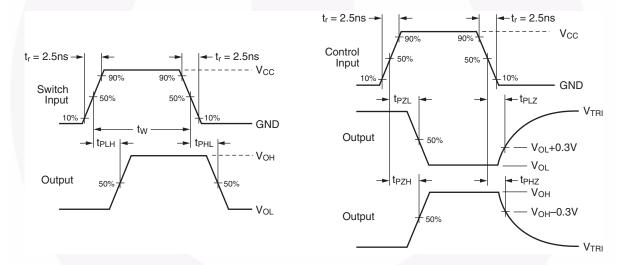


Figure 8. AC Waveforms

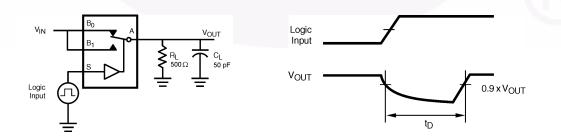


Figure 9. Break-Before-Make Interval Timing

#### AC Loading and Waveforms (continued)

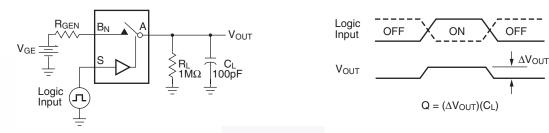


Figure 10. Charge Injection Test

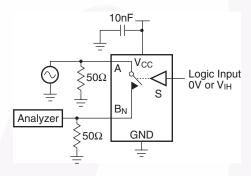
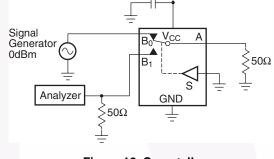


Figure 11. Off Isolation



10nF

Figure 12. Crosstalk

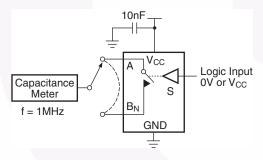


Figure 13. Channel Off Capacitance

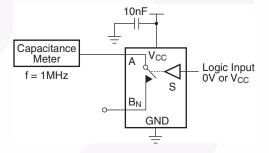


Figure 14. Channel On Capacitance

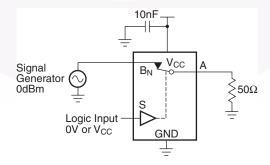
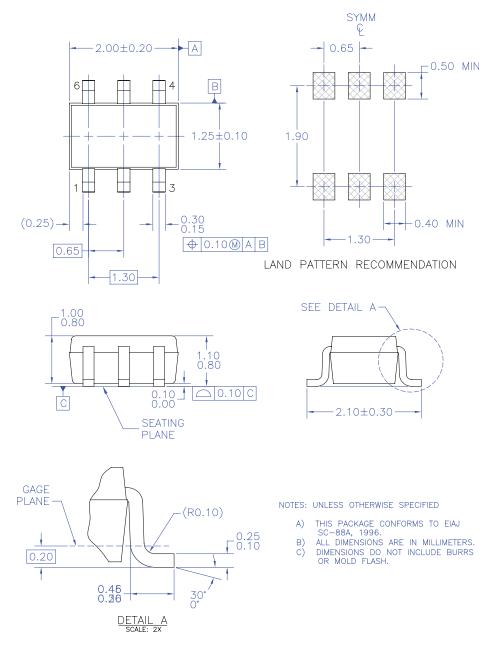


Figure 15. Bandwidth

#### **Physical Dimensions**



MAA06ARFV5

Figure 16. 6-Lead, SC70, EIAJ SC88, 1.25mm Wide Package

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Datasheet Identification	Product Status	Definition			
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Rev. 140

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